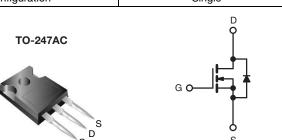


Vishay Siliconix

## **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	50	500				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.15				
Q <sub>g</sub> (Max.) (nC)	210	210				
Q <sub>gs</sub> (nC)	58	58				
Q <sub>gd</sub> (nC)	100					
Configuration	Single					



#### N-Channel MOSFET

#### **FEATURES**

• Super Fast Body Diode Eliminates the Need for External Diodes in ZVS Applications



• Lower Gate Charge Results in Simpler Drive RoHS Requirements

- Enhanced dV/dt Capabilities Offer Improved Ruggedness
- Higher Gate Voltage Threshold Offers Improved Noise Immunity
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supplies
- Motor Control Applications

ORDERING INFORMATION			
Package	TO-247AC		
Lead (Pb)-free	IRFP31N50LPbF		
Lead (FD)-life	SiHFP31N50L-E3		
SnPb	IRFP31N50L		
SIFD	SiHFP31N50L		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	500	V	
Gate-Source Voltage			$V_{GS}$	± 30	7 °	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	- I <sub>D</sub>	31		
Continuous Drain Current	VGS at 10 V	T <sub>C</sub> = 100 °C		20	A	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	124		
Linear Derating Factor				3.7	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	460	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	31	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	46	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	460	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	19	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	7	
Mounting Toyour	6.20.0*	0.00 140		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting  $T_J$  = 25 °C, L = 1 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 31 A (see fig. 12).
- c.  $I_{SD} \leq 31$  A,  $dI/dt \leq 422$  A/µs,  $V_{DD} \leq V_{DS},\, T_{J} \leq 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFP31N50L, SiHFP31N50L

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.26		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.28	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zana Oata Wallana Barin Oamad		V <sub>DS</sub> =	500 V, V <sub>GS</sub> = 0 V	-	-	50	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2.0	mA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 19 A <sup>b</sup>	-	0.15	0.18	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 19 A <sup>b</sup>	15	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	5000	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$	-	553	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	0 MHz, see fig. 5	-	59	-	
Outrat Conscitence	0		V <sub>DS</sub> = 1.0 V , f = 1.0 MHz	-	6630	-	pF
Output Capacitance	$C_{oss}$	.,	V <sub>DS</sub> = 400 V , f = 1.0 MHz	-	155	-	
Effective Output Capacitance	C <sub>oss</sub> eff.	V <sub>GS</sub> = 0 V		-	276	-	
Effective Output Capacitance	Coss eff. (ER)	1	$V_{DS} = 0 \text{ V to } 400 \text{ V}^{c}$	-	200	-	1
Total Gate Charge	Qg			-	-	210	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 31 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 7 and 13 <sup>b</sup>		-	-	58	nC
Gate-Drain Charge	Q <sub>gd</sub>	1	see lig. 7 and 10	-	-	100	1
Internal Gate Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	1.1	-	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 250 V, $I_{D}$ = 31 A, $R_{g}$ = 4.3 $\Omega$ , see fig. 10 <sup>b</sup>		-	28	-	ns
Rise Time	t <sub>r</sub>			-	115	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	54	-	
Fall Time	t <sub>f</sub>			-	53	-	1
Drain-Source Body Diode Characteristic	s				I.	•	<u> </u>
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	31	^
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	124	- A
Body Diode Voltage	$V_{SD}$	$T_J = 25 ^{\circ}\text{C},  I_S = 31  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 31 A		-	170	250	
		T <sub>J</sub> = 125 °C, dl/dt = 100 A/μs <sup>b</sup>		-	220	330	ns
Rady Diada Dayaraa Daaaaa Cha	0	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 31 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	570	860	nC
Body Diode Reverse Recovery Charge	se Recovery Charge I O —————		°C, dl/dt = 100 A/µsb	-	1.2	1.8	μC
Reverse Recovery Current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	7.9	12	A
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). Pulse width  $\leq 300~\mu s$ ; duty cycle  $\leq 2~\%$ . Coss eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .  $C_{oss}$  eff. (ER) is a fixed capacitance that stores the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

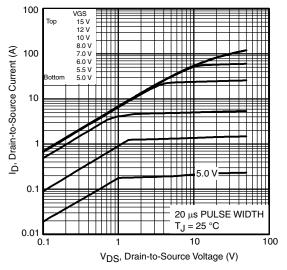


Fig. 1 - Typical Output Characteristics

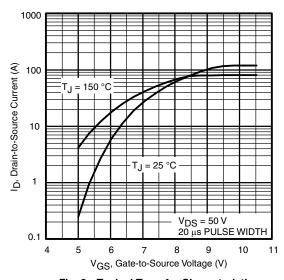


Fig. 3 - Typical Transfer Characteristics

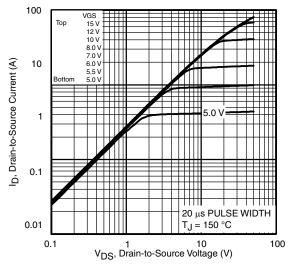


Fig. 2 - Typical Output Characteristics

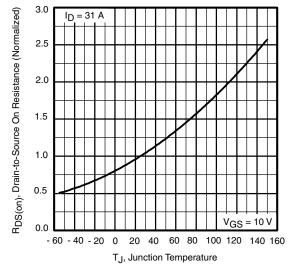


Fig. 4 - Normalized On-Resistance vs. Temperature

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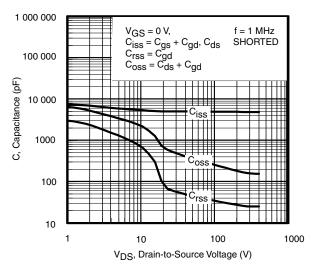


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

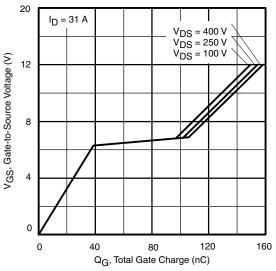


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

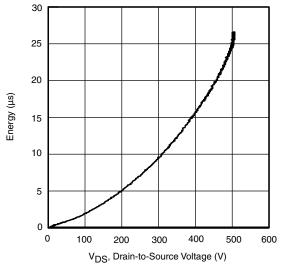


Fig. 6 - Output Capacitance Stored Energy vs. V<sub>DS</sub>

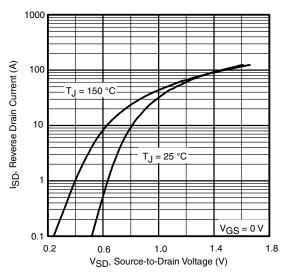


Fig. 8 - Typical Source Drain Diode Forward Voltage



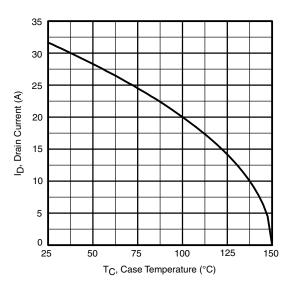


Fig. 9 - Maximum Drain Current vs. Case Temperature

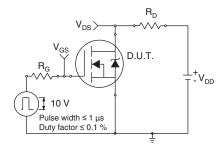


Fig. 10a - Switching Time Test Circuit

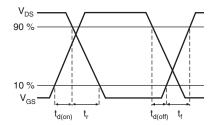


Fig. 10b - Switching Time Waveforms

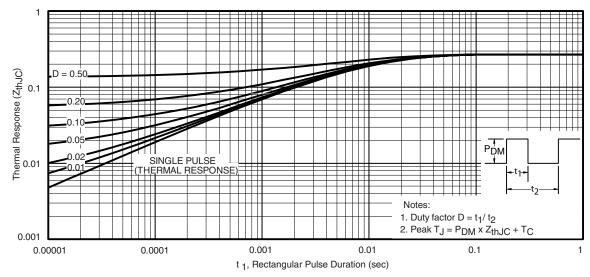


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

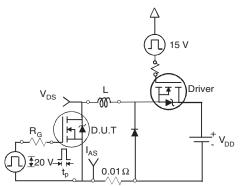


Fig. 12a - Unclamped Inductive Test Circuit

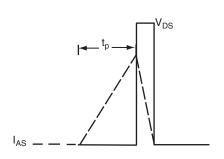


Fig. 12b - Unclamped Inductive Waveforms

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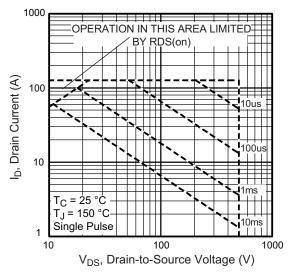
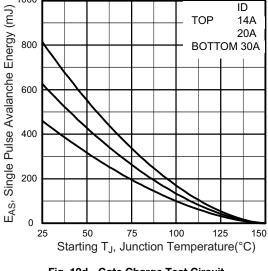


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



1000

Fig. 12d - Gate Charge Test Circuit

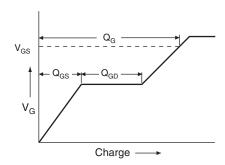


Fig. 13a - Maximum Safe Operating Area

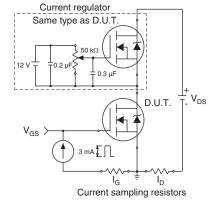
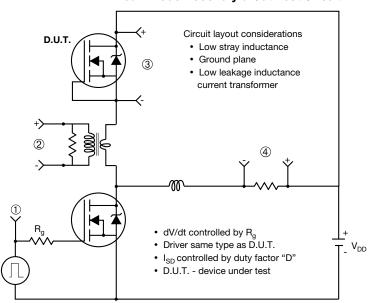


Fig. 13b - Basic Gate Charge Waveform



#### Peak Diode Recovery dV/dt Test Circuit



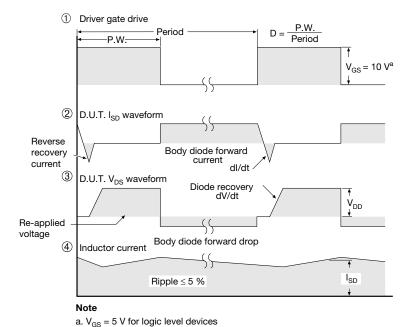
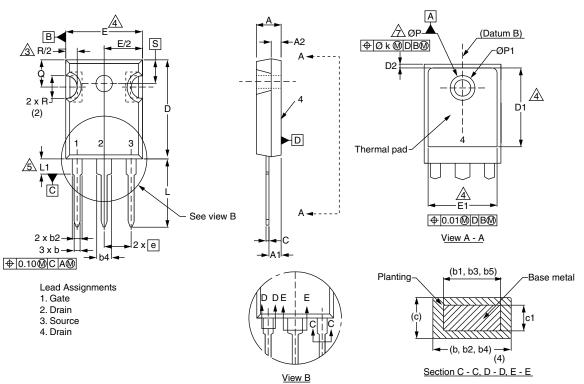


Fig. 14 - For N-Channel

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# **TO-247AC (High Voltage)**



	MILLIMETERS		MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.58	5.31	0.180	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.17	2.49	0.046	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.53	2.39	0.060	0.094		
b3	1.65	2.37	0.065	0.093		
b4	2.42	3.43	0.095	0.135		
b5	2.59	3.38	0.102	0.133		
С	0.38	0.86	0.015	0.034		
c1	0.38	0.76	0.015	0.030		
D	19.71	20.82	0.776	0.820		
D1	13.08	-	0.515	-		

	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
E	15.29	15.87	0.602	0.625
E1	13.72	ı	0.540	ı
е	5.46	BSC	0.215 BSC	
Øk	0.2	254	0.010	
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
N	7.62 BSC		0.300	BSC
ØΡ	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51 BSC		0.217 BSC	
0.217 800				

ECN: X13-0103-Rev. D, 01-Jul-13

DWG: 5971

### **Notes**

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
  5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.





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